Diode Semiconductor Device - Page 1 of 1



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Inclosure Material:

Ceramic

Mounting Method:

Press fit

Features Provided:

Hermetically sealed case

Semiconductor Material:

Silicon

Test Data Document:

10001-1793518 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.;

excludes any specification, standard or other document that may be referenced in a basic governing drawing)

Terminal Type And Quantity:

1 case and 1 ferrule

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

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